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<p>1. Name of conveying party(ies): Walter Riess Samuel C. Strite</p> <p>Additional name(s) of conveying party(ies) attached? <u>Yes</u> <input checked="" type="checkbox"/> No</p> <p style="text-align: center;"><b>2-8-99</b></p>	<p>2. Name and address of receiving party(ies): Name: IBM Corporation Address: New Orchard Road Armonk, NY 10504</p> <p>Additional name(s) &amp; addresses attached? <u>Yes</u> <input checked="" type="checkbox"/> No</p>
<p>3. Nature of conveyance: <input checked="" type="checkbox"/> Assignment Execution Date(s): <u>October 1, 1998</u> <u>and October 6, 1998</u></p>	<p>4. Patent Application number(s) Serial No. <u>09/155,591</u> Execution Date(s): <u>September 30, '98</u></p>
<p>5. Name and address of party to whom correspondence concerning document should be mailed: Name: David M. Shofi Address: IBM Corporation Intellectual Property Law P.O. Box 218 Yorktown Heights, NY 10598</p>	<p>6. Total number of applications involved: <u>1</u></p> <p>7. Total fee (37 CFR 3.41): <u>\$40.00</u> <input checked="" type="checkbox"/> Charge to Deposit Account No.: <u>09-0468</u> (A duplicate copy of this sheet is enclosed)</p>

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8. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of original document.

David M. Shofi (Reg. No. 39,835)

Name of Person Signing	Signature	Date
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**ASSIGNMENT**

Whereas, we

(1) Walter RIESS  
City of Adliswil  
and Country of Switzerland

and (2) Samuel C. STRITE  
City of Adliswil  
and Country of Switzerland

have invented certain improvements in

**NON-DEGENERATE WIDE BANDGAP SEMICONDUCTORS AS INJECTION LAYERS AND/OR CONTACT ELECTRODES FOR ORGANIC ELECTROLUMINESCENT DEVICES**

and have executed, respectively, a United States patent application therefore on

(1) 6 October 1998 and (2) 1 October 1998

And whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we the above named hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

SIGNED AND SEALED

(1) at Adliswil  
on 6 October 1998



Walter Riess

(2) at Adliswil  
on 1 October 1998



Samuel C. Strite